

7-Feb.-19: Save the date!

From layout to chips



Annual meeting - agenda

09:00	Welcome coffee		
09:15-09:25	Introduction	J-Christophe Crébier	CMP
09:25-09:40	2018 activity results	Kholdoun Torki	CMP
09:40-09:55	STMicroelectronics MPW services	Ajith-Sivadasan Moreau	CMP
09:55-10:15	Imaging Technologies at STMicroelectronics	Sara Pellegrini	STMicroelectronics
10:15-10:25	28nm FD-SOI RTL to GDS design flow tutorial, new developments	Christelle Rabache	CMP
10:25-10:40	Flip-chip & Advanced packaging	Lyubomir Kerachev	CMP
10:40-11:10	Break discussion		
11:10-11:25	0.35 μ m, 0.18 μ m MPW services	Kholdoun Torki	CMP
11:25-11:45	EM Microelectronic Marin Ultra low power technology services through CMP	Christian Terrier	EM Microelectronic
11:45-12:05	ON Semi technology services through CMP	Stefan Vanhaeverbeke	ON Semi
12:05-12:20	MEMS & Photonics MPW services, MIRPHAB	François Berthollet	CMP
12:20-12:30	NEXTS (EUROPRACTICE)	Kholdoun Torki	CMP
12:30-12:40	myCMP: MPW specialized web application	Alexandre Chagoya	CMP
12:40-12:50	Add-on services	Jérémy Perret	CMP
12:50-13:00	Closing remarks	J-Christophe Crébier	CMP
13:00-14:30	Lunch discussion		